

## Silicon Diffused Power Transistor

BU2508DF

## GENERAL DESCRIPTION

Enhanced performance, new generation, high-voltage, high-speed switching npn transistor with an integrated damper diode in a plastic full-pack envelope intended for use in horizontal deflection circuits of colour television receivers. Features exceptional tolerance to base drive and collector current load variations resulting in a very low worst case dissipation.

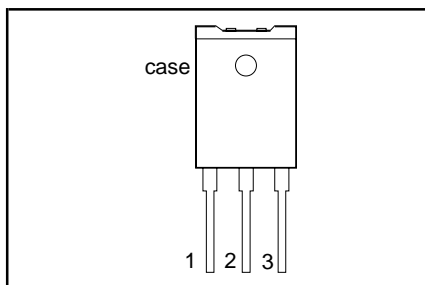
## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0$ V	-	1500	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	700	V
$I_C$	Collector current (DC)		-	8	A
$I_{CM}$	Collector current peak value		-	15	A
$P_{tot}$	Total power dissipation	$T_{hs} \leq 25$ °C	-	45	W
$V_{CEsat}$	Collector-emitter saturation voltage	$I_C = 4.5$ A; $I_B = 1.12$ A	-	1.0	V
$I_{Csat}$	Collector saturation current		4.5	-	A
$V_F$	Diode forward voltage	$I_F = 4.5$ A	1.6	2.0	V
$t_f$	Fall time	$I_{Csat} = 4.5$ A; $I_{B(end)} = 1.1$ A	0.4	0.6	µs

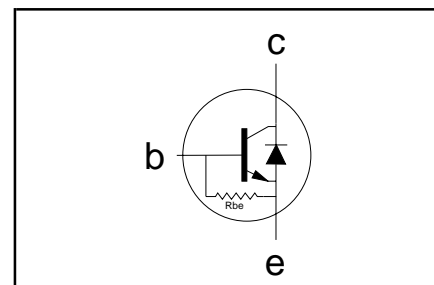
## PINNING - SOT199

PIN	DESCRIPTION
1	base
2	collector
3	emitter
case	isolated

## PIN CONFIGURATION



## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0$ V	-	1500	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	700	V
$I_C$	Collector current (DC)		-	8	A
$I_{CM}$	Collector current peak value		-	15	A
$I_B$	Base current (DC)		-	4	A
$I_{BM}$	Base current peak value		-	6	A
$-I_{B(AV)}$	Reverse base current	average over any 20 ms period	-	100	mA
$-I_{BM}$	Reverse base current peak value <sup>1</sup>		-	5	A
$P_{tot}$	Total power dissipation	$T_{hs} \leq 25$ °C	-	45	W
$T_{stg}$	Storage temperature		-65	150	°C
$T_j$	Junction temperature		-	150	°C

<sup>1</sup> Turn-off current.

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## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Junction to heatsink	without heatsink compound	-	3.7	K/W
$R_{th\ j-hs}$	Junction to heatsink	with heatsink compound	-	2.8	K/W
$R_{th\ j-a}$	Junction to ambient	in free air	35	-	K/W

## ISOLATION LIMITING VALUE &amp; CHARACTERISTIC

 $T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{isol}$	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65\%$ ; clean and dustfree	-		2500	V
$C_{isol}$	Capacitance from T2 to external heatsink	$f = 1\text{ MHz}$	-	22	-	pF

## STATIC CHARACTERISTICS

 $T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CES}$	Collector cut-off current <sup>2</sup>	$V_{BE} = 0\text{ V}$ ; $V_{CE} = V_{CESMmax}$	-	-	1.0	mA
$I_{CES}$		$V_{BE} = 0\text{ V}$ ; $V_{CE} = V_{CESMmax}$ $T_j = 125\text{ }^{\circ}\text{C}$	-	-	2.0	mA
$I_{EBO}$	Emitter cut-off current	$V_{EB} = 7.5\text{ V}$ ; $I_C = 0\text{ A}$	-	227	-	mA
$BV_{EBO}$	Emitter-base breakdown voltage	$I_B = 600\text{ mA}$	7.5	13.5	-	V
$R_{be}$	Base-emitter resistance	$V_{EB} = 7.5\text{ V}$	-	33	-	$\Omega$
$V_{CEOsust}$	Collector-emitter sustaining voltage	$I_B = 0\text{ A}$ ; $I_C = 100\text{ mA}$ ; $L = 25\text{ mH}$	700	-	-	V
$V_{CEsat}$	Collector-emitter saturation voltage	$I_C = 4.5\text{ A}$ ; $I_B = 1.12\text{ A}$	-	-	1.0	V
$V_{BEsat}$	Base-emitter saturation voltage	$I_C = 4.5\text{ A}$ ; $I_B = 1.7\text{ A}$	-	-	1.1	V
$h_{FE}$	DC current gain	$I_C = 1\text{ A}$ ; $V_{CE} = 5\text{ V}$	-	13	-	
$h_{FE}$		$I_C = 4.5\text{ A}$ ; $V_{CE} = 1\text{ V}$	4	5.5	7.0	
$V_F$	Diode forward voltage	$I_F = 4.5\text{ A}$	-	1.6	2.0	V

## DYNAMIC CHARACTERISTICS

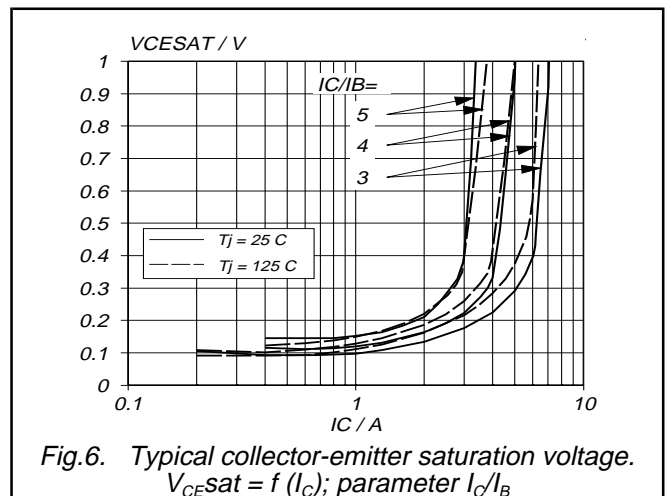
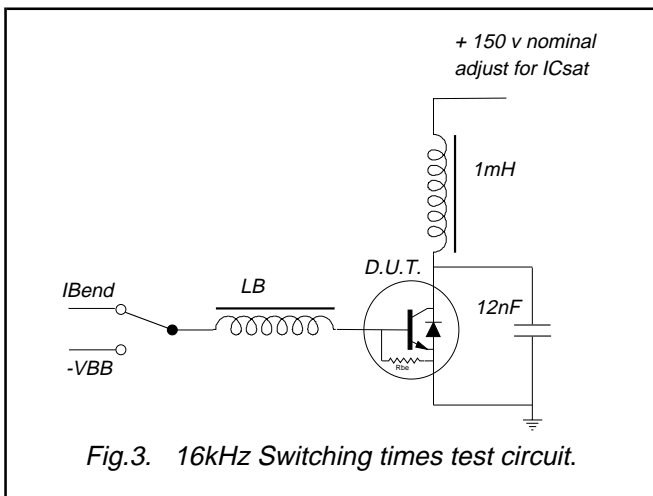
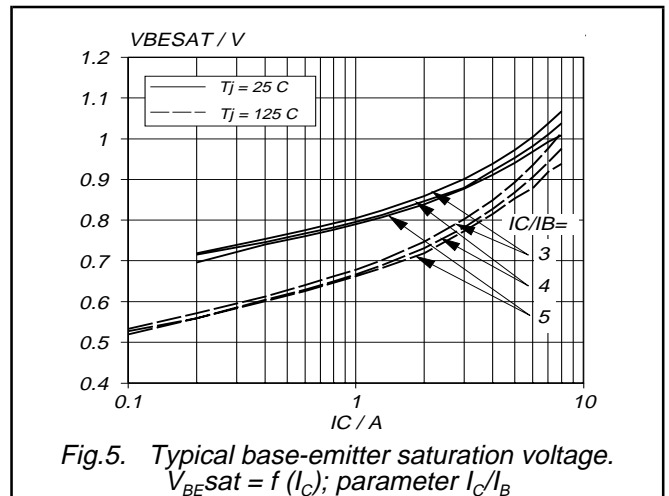
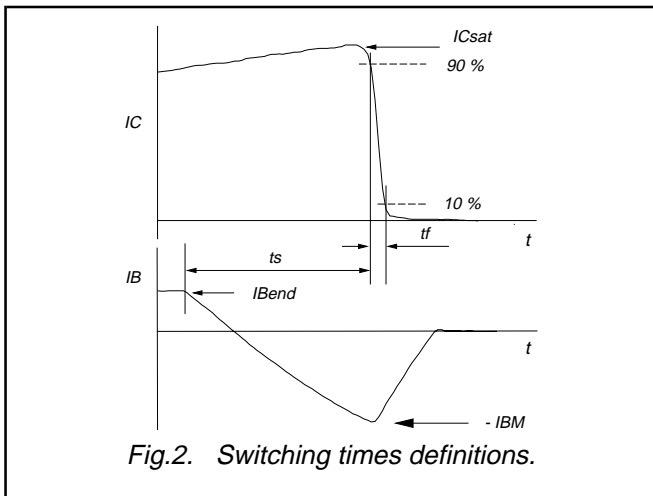
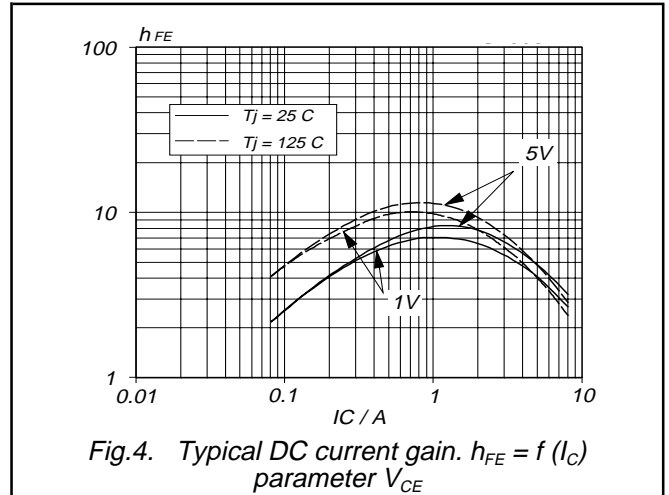
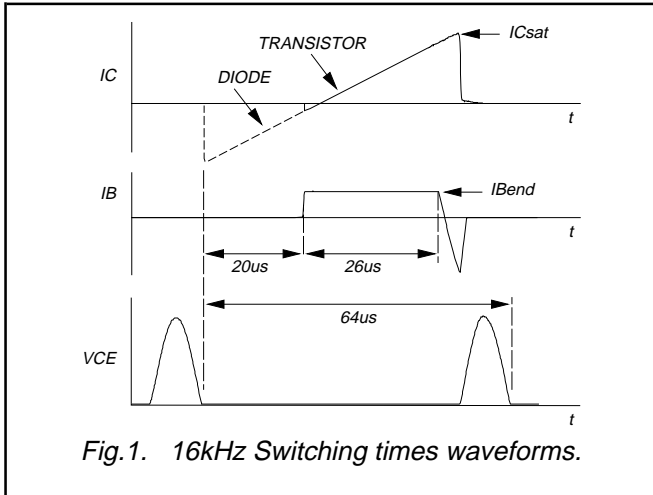
 $T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$C_c$	Collector capacitance	$I_E = 0\text{ A}$ ; $V_{CB} = 10\text{ V}$ ; $f = 1\text{ MHz}$	80	-	pF
$t_s$	Switching times (16 kHz line deflection circuit)	$I_{Csat} = 4.5\text{ A}$ ; $I_{B(end)} = 1.1\text{ A}$ ; $L_B = 6\text{ }\mu\text{H}$ ; $-V_{BB} = 4\text{ V}$ ; $(-di_B/dt = 0.6\text{ A}/\mu\text{s})$			
$t_s$	Turn-off storage time		5.0	6.0	$\mu\text{s}$
$t_f$	Turn-off fall time		0.4	0.6	$\mu\text{s}$
$t_s$	Switching times (38 kHz line deflection circuit)	$I_{Csat} = 4.0\text{ A}$ ; $I_{B(end)} = 0.9\text{ A}$ ; $L_B = 6\text{ }\mu\text{H}$ ; $-V_{BB} = 4\text{ V}$ ; $(-di_B/dt = 0.6\text{ A}/\mu\text{s})$			
$t_s$	Turn-off storage time		4.7	5.7	$\mu\text{s}$
$t_f$	Turn-off fall time		0.25	0.35	$\mu\text{s}$

<sup>2</sup> Measured with half sine-wave voltage (curve tracer).

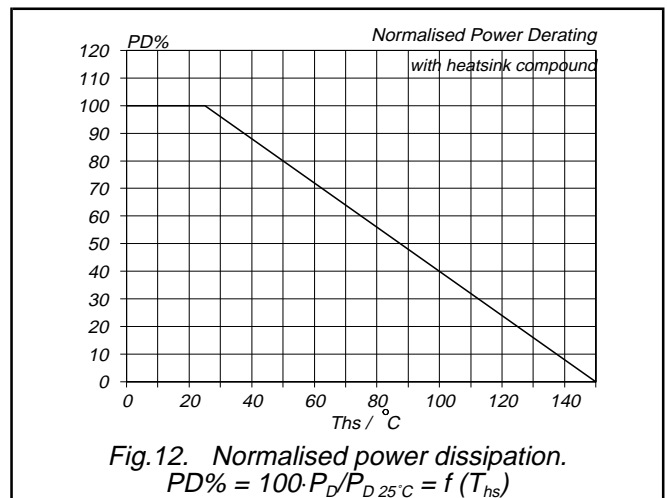
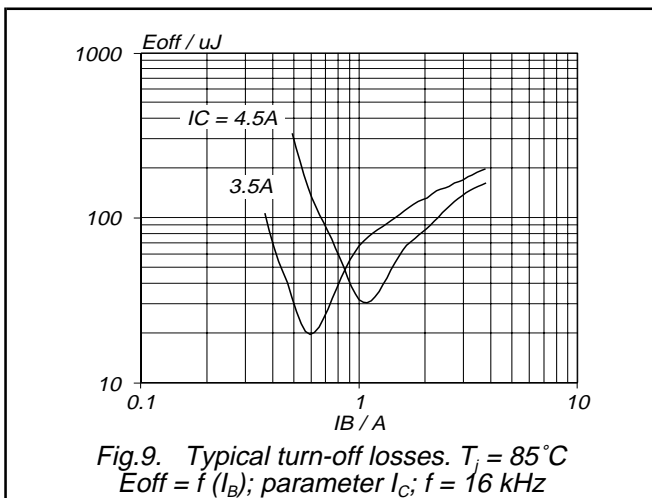
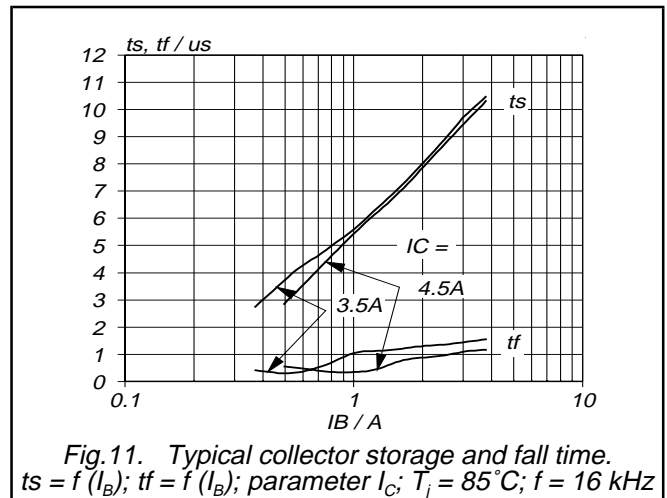
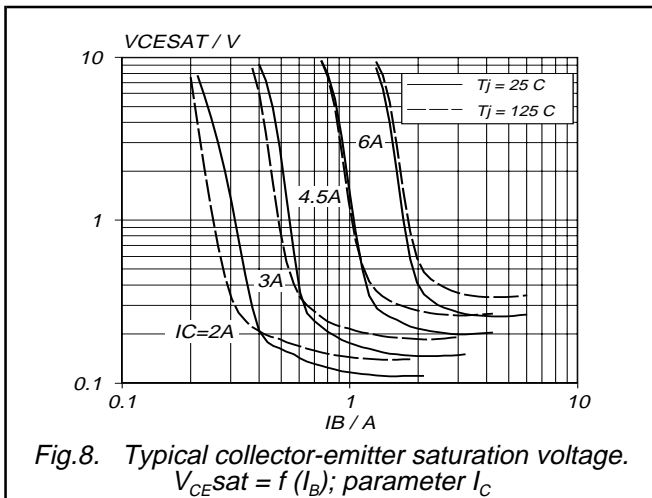
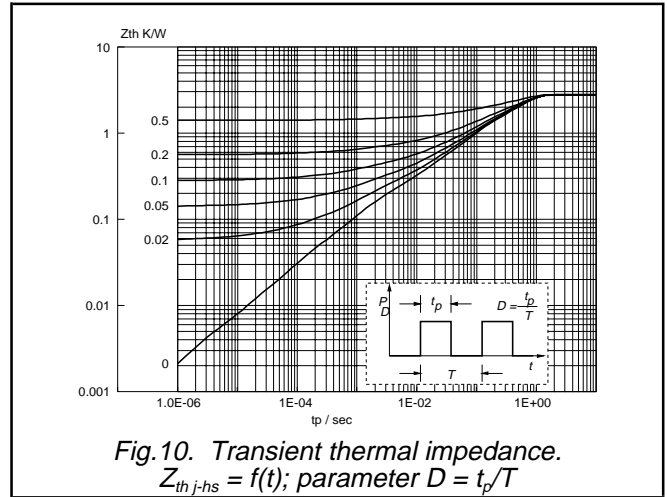
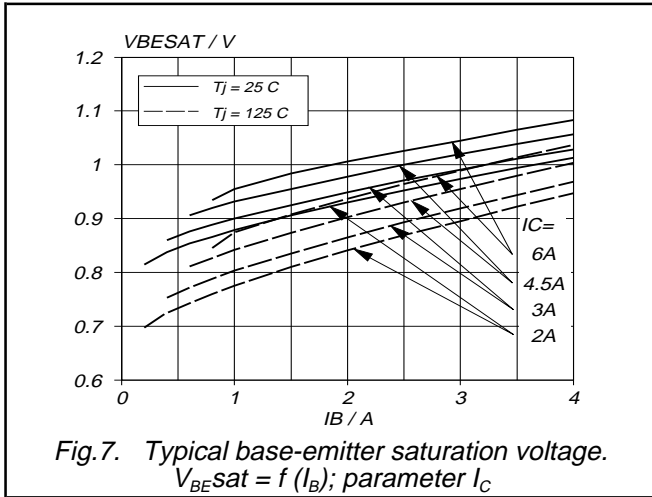
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Fig. 13. Forward bias safe operating area.  $T_{hs} = 25^{\circ}\text{C}$   
 I Region of permissible DC operation.  
 II Extension for repetitive pulse operation.

NB: Mounted with heatsink compound and  $30 \pm 5$  newton force on the centre of the envelope.



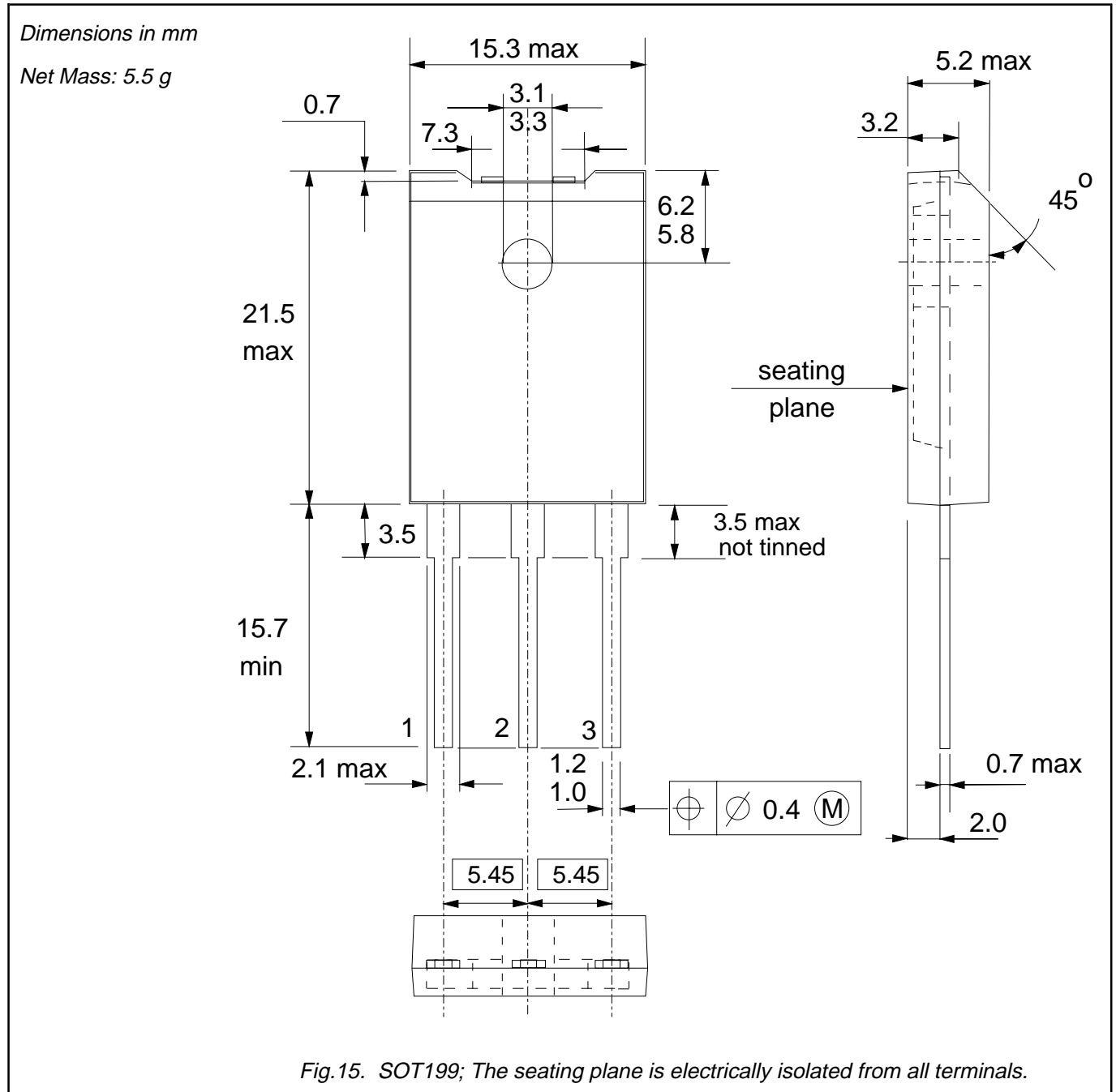
Fig. 14. Forward bias safe operating area.  $T_{hs} = 25^{\circ}\text{C}$   
 I Region of permissible DC operation.  
 II Extension for repetitive pulse operation.

NB: Mounted without heatsink compound and  $30 \pm 5$  newton force on the centre of the envelope.

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**MECHANICAL DATA**



**Notes**

- 1. Refer to mounting instructions for F-pack envelopes.
- 2. Epoxy meets UL94 V0 at 1/8".

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**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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